

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Francois Hebert	06/30/2008
Tao Feng	06/30/2008
Jun Lu	06/30/2008
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ALPHA & OMEGA SEMICONDUCTOR, LTD
<b>Street Address:</b>	Cannon's Court 22, Victoria Street
<b>City:</b>	Hamilton HM12
<b>State/Country:</b>	BERMUDA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	12165423
<b>CORRESPONDENCE DATA</b>	
Fax Number:	(510)668-0239
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	510-668-0965
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Correspondent Name:	Joshua D. Isenberg
Address Line 1:	809 Corporate Way
Address Line 4:	Fremont, CALIFORNIA 94539
ATTORNEY DOCKET NUMBER:	ANO-015/US
NAME OF SUBMITTER:	JOSHUA D. ISENBERG
Total Attachments: 3 source=ANO-015_assignment#page1.tif source=ANO-015_assignment#page2.tif source=ANO-015_assignment#page3.tif	

OP \$40.00 12165423

**ASSIGNMENT**

**INVENTOR  
AND CITY**

Whereas, I, **François Hébert** of 18 Melrose Court  
San Mateo, CA 94402

have invented:

**TITLE:**

**PLANAR GROOVED POWER INDUCTOR STRUCTURE AND  
METHOD**

**DATE INVENTOR  
SIGNED THE  
DECLARATION**

and executed a United States patent application therefor

on June 30<sup>th</sup>, 2008. Said assignor hereby authorize and request  
their attorney, Joshua D. Isenberg, of 809 Corporate Way, Fremont,  
California, to insert here in parentheses (Application number  
12/165,423 JDI, filed June 30, 2008 JDI) the filing  
date and application number of said application when known.

Whereas, **Alpha & Omega Semiconductor, LTD**, a Bermuda  
Company, having its registered address at Cannon's Court 22, Victoria  
Street, Hamilton HM12, Bermuda, (hereinafter called **AOS**), desires to  
acquire the entire right, title and interest of said application and invention,  
and to any United States and foreign patents to be obtained therefore;

Now therefore for a valuable consideration, receipt whereof is  
hereby acknowledged, I, the above named, hereby sell, assign, and transfer  
to **AOS**, its successors and assigns, the entire right, title and interest in the  
said application and invention therein disclosed for the United States and  
foreign countries, and all rights of priority resulting from the filing said  
United States application, and I request the Commissioner of Patents to  
issue any Letters Patent granted upon the invention set forth in said  
application to **AOS** its successors and assigns; and I hereby agree that  
**AOS** may apply for foreign Letters Patent on said invention and I will  
execute all papers necessary in connection with the United States and  
foreign applications when called upon to do so by

**CITY AND**

Signed and Sealed at Sunnyvale, CA

**DATE**

on June 30<sup>th</sup>, 2008

  
\_\_\_\_\_  
SIGNATURE OF INVENTOR

**ASSIGNMENT**

**INVENTOR  
AND CITY**

Whereas, I, **Tao Feng** of 900 Pepper Tree Lane #125  
Santa Clara, CA 95051

have invented:

**TITLE:**

**PLANAR GROOVED POWER INDUCTOR STRUCTURE AND  
METHOD**

**DATE INVENTOR  
SIGNED THE  
DECLARATION**

and executed a United States patent application therefor

on June 30, 2008. Said assignor hereby authorize and request  
their attorney, Joshua D. Isenberg, of 809 Corporate Way, Fremont,  
California, to insert here in parentheses (Application number  
12/165,423, filed June 30, 2008 jsj) the filing  
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and to any United States and foreign patents to be obtained therefore;

Now therefore for a valuable consideration, receipt whereof is  
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to **AOS**, its successors and assigns, the entire right, title and interest in the  
said application and invention therein disclosed for the United States and  
foreign countries, and all rights of priority resulting from the filing said  
United States application, and I request the Commissioner of Patents to  
issue any Letters Patent granted upon the invention set forth in said  
application to **AOS** its successors and assigns; and I hereby agree that  
**AOS** may apply for foreign Letters Patent on said invention and I will  
execute all papers necessary in connection with the United States and  
foreign applications when called upon to do so by

**CITY AND**

Signed and Sealed at Sunnyvale

**DATE**

on June 30, 2008

  
SIGNATURE OF INVENTOR

**ASSIGNMENT**

**INVENTOR AND CITY** Whereas, I, **Jun Lu** of 4135 Arezzo Pointe Ln  
San Jose, CA 95148

have invented:

**TITLE:** **PLANAR GROOVED POWER INDUCTOR STRUCTURE AND METHOD**

**DATE INVENTOR SIGNED THE DECLARATION** and executed a United States patent application therefor  
on June 30th, 2008. Said assignor hereby authorize and request

their attorney, Joshua D. Isenberg, of 809 Corporate Way, Fremont, California, to insert here in parentheses (Application number 12/165,423 JJ, filed June 30, 2008 JJ) the filing date and application number of said application when known.

Whereas, **Alpha & Omega Semiconductor, LTD**, a Bermuda Company, having its registered address at Cannon's Court 22, Victoria Street, Hamilton HM12, Bermuda, (hereinafter called **AOS**), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to **AOS**, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to **AOS** its successors and assigns; and I hereby agree that **AOS** may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

**CITY AND** Signed and Sealed at Sunnyvale, CA

**DATE** on June 30th, 2008

  
SIGNATURE OF INVENTOR